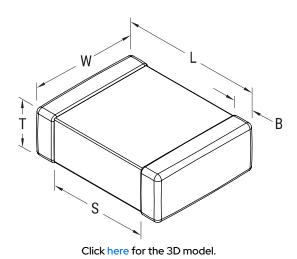




SMD Auto X7R FO, Ceramic, 1 uF, 20%, 50 VDC, X7R, SMD, MLCC, Open Mode, Automotive Grade, 1206, 1.5 mm



General Information		
Series	SMD Auto X7R FO	
Style	SMD Chip	
Description	SMD, MLCC, Open Mode, Automotive Grade	
Features	Open Mode, Automotive Grade	
RoHS	Yes	
Termination	Tin	
Marking	No	
Qualifications	AEC-Q200	
AEC-Q200	Yes	
Typical Component Weight	41 mg	
Shelf Life	78 Weeks	
MSL	1	

1206
3.2mm +/-0.2mm
1.6mm +/-0.2mm
1.6mm +/-0.20mm
1.5mm MIN
0.5mm +/-0.25mm

T	1.6mm +/-0.20mm
S	1.5mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	

Specifications		
Capacitance	1uF	
Measurement Condition	1 kHz 1.0Vrms	
Tolerance	20%	
Voltage DC	50 VDC	
Dielectric Withstanding Voltage	125 VDC	
Temperature Range	-55/+125°C	
Temp. Coefficient	X7R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms	
Dissipation Factor	2.5% 1 kHz 1.0Vrms	
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	500 MOhms	

Т	1.6mm +/-0.20mm	Voltage DC	50 VDC
S	1.5mm MIN	Dielectric Withstanding Voltage	125 VDC
В	0.5mm +/-0.25mm	Temperature Range	-55/+125°C
		Temp. Coefficient	X7R
Packaging Specifications		Capacitance Change with	15%, 1kHz 1.0Vrms
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity 2000	Dissipation Factor	2.5%1kHz1.0Vrms	
		Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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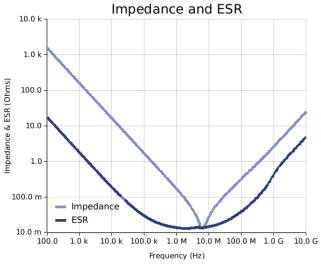


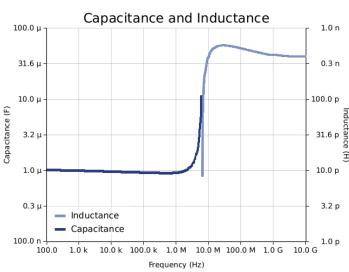


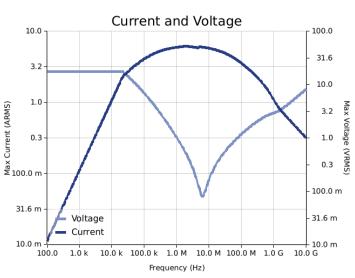
SMD Auto X7R FO, Ceramic, 1 uF, 20%, 50 VDC, X7R, SMD, MLCC, Open Mode, Automotive Grade, 1206, 1.5 mm

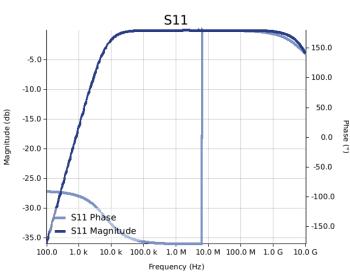
Simulations

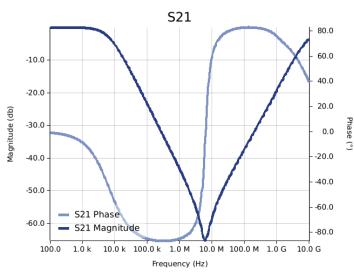
For the complete simulation environment please visit K-SIM.

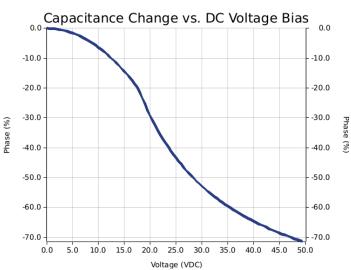










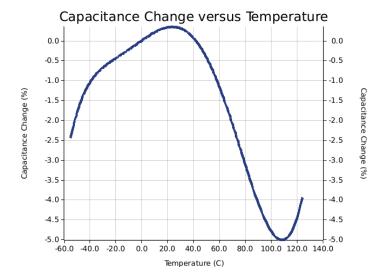


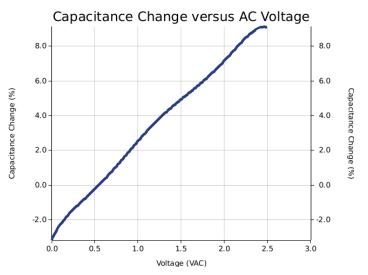
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C1206F105M5RACAUTO

SMD Auto X7R FO, Ceramic, 1 uF, 20%, 50 VDC, X7R, SMD, MLCC, Open Mode, Automotive Grade, 1206, 1.5 mm





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C1206F105M5RACAUTO

SMD Auto X7R FO, Ceramic, 1 uF, 20%, 50 VDC, X7R, SMD, MLCC, Open Mode, Automotive Grade, 1206, 1.5 mm

These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for ripple Ripple Currenty votage vs. rrequency plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
 The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
 The effects shown herein are based on measured data from a multiple part sample of the parts in question.
 Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages
- generated at any other harmonics.

 Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.

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